

G500

Peel ply

Ideally suited to aerospace phenolic resin applications

Features

- Porous, medium weight polyester peel ply.
- Heat set and scoured, for use directly against laminates or bond lines.
- Available coated and non-coated, depending on user requirement.
- Recommended for composite manufacture and metal bonding applications.
- Coloured dark green for ease of detection on the cured laminate.
- Recommended for use with phenolic resins.
- Imparts a coarse weave pattern upon removal from the laminate.

Properties

Maximum use temperature	180°C	356°F
Colour	Dark green	
Fabric type	Polyester	
Fabric weight	94g/m ²	2.81oz/yd ²

Availability

Standard width	1.52m	1.66yd
Standard length	100m	109yd
	Slit widths available	

Storage

No special storage conditions required.

Health & safety

Handling of these products must conform to individual company guidelines and health and safety regulations.

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